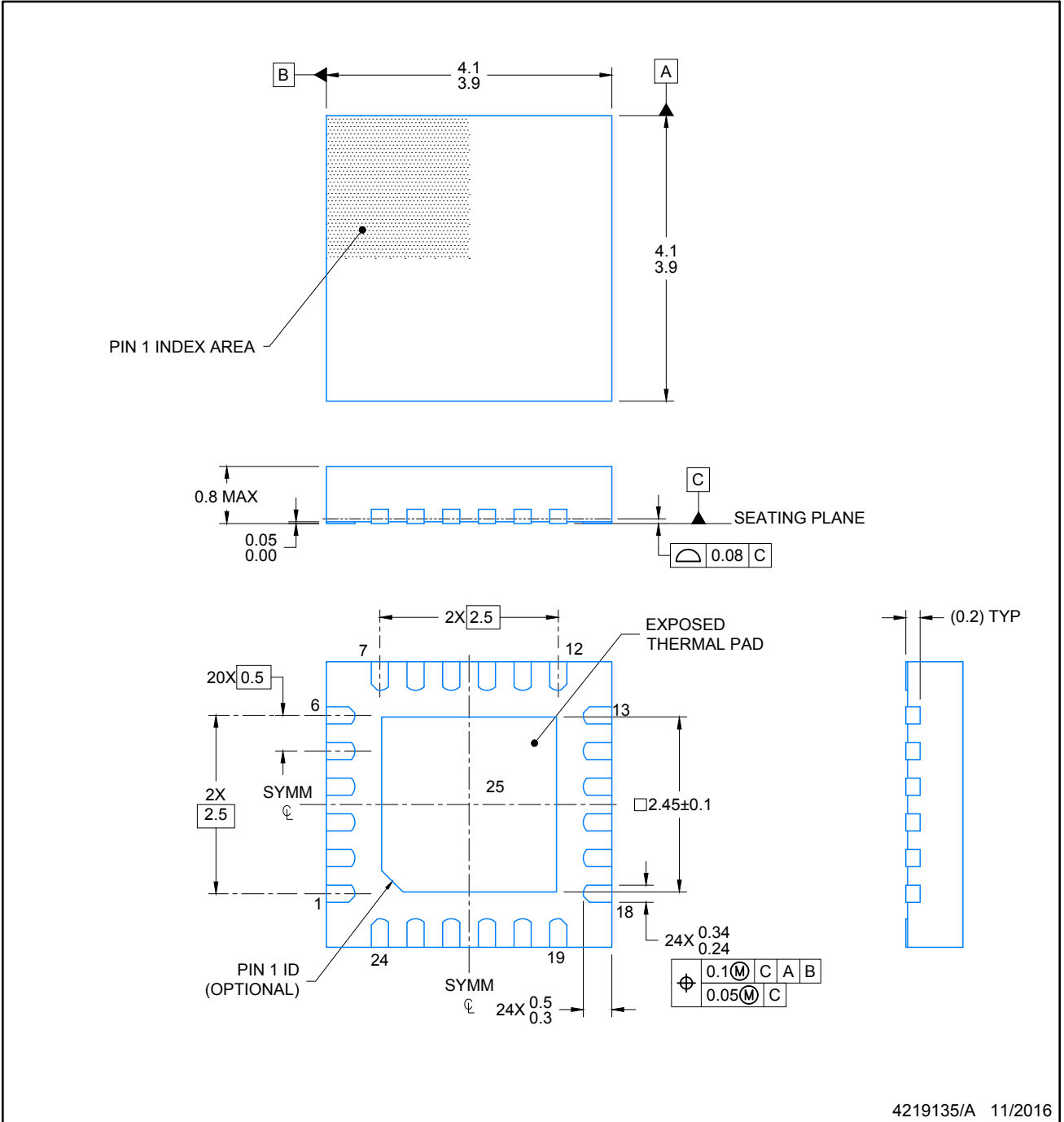


# PACKAGE OUTLINE

RTW0024B

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK-NO LEAD



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NOTES:

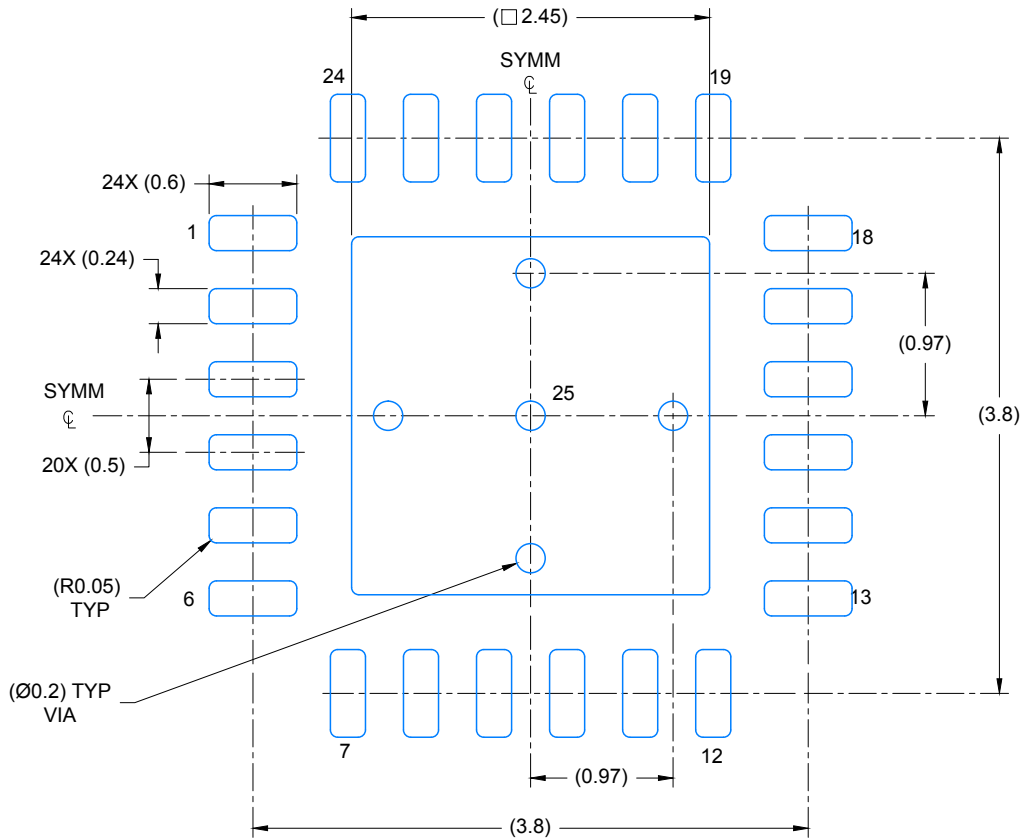
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

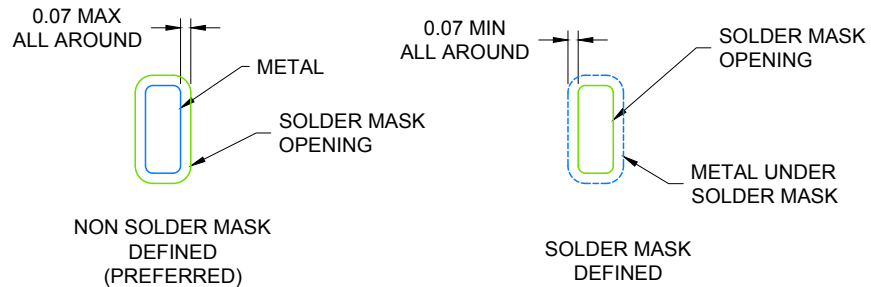
WQFN - 0.8 mm max height

RTW0024B

PLASTIC QUAD FLATPACK-NO LEAD



LAND PATTERN EXAMPLE  
SCALE: 20X



SOLDER MASK DETAILS

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NOTES: (continued)

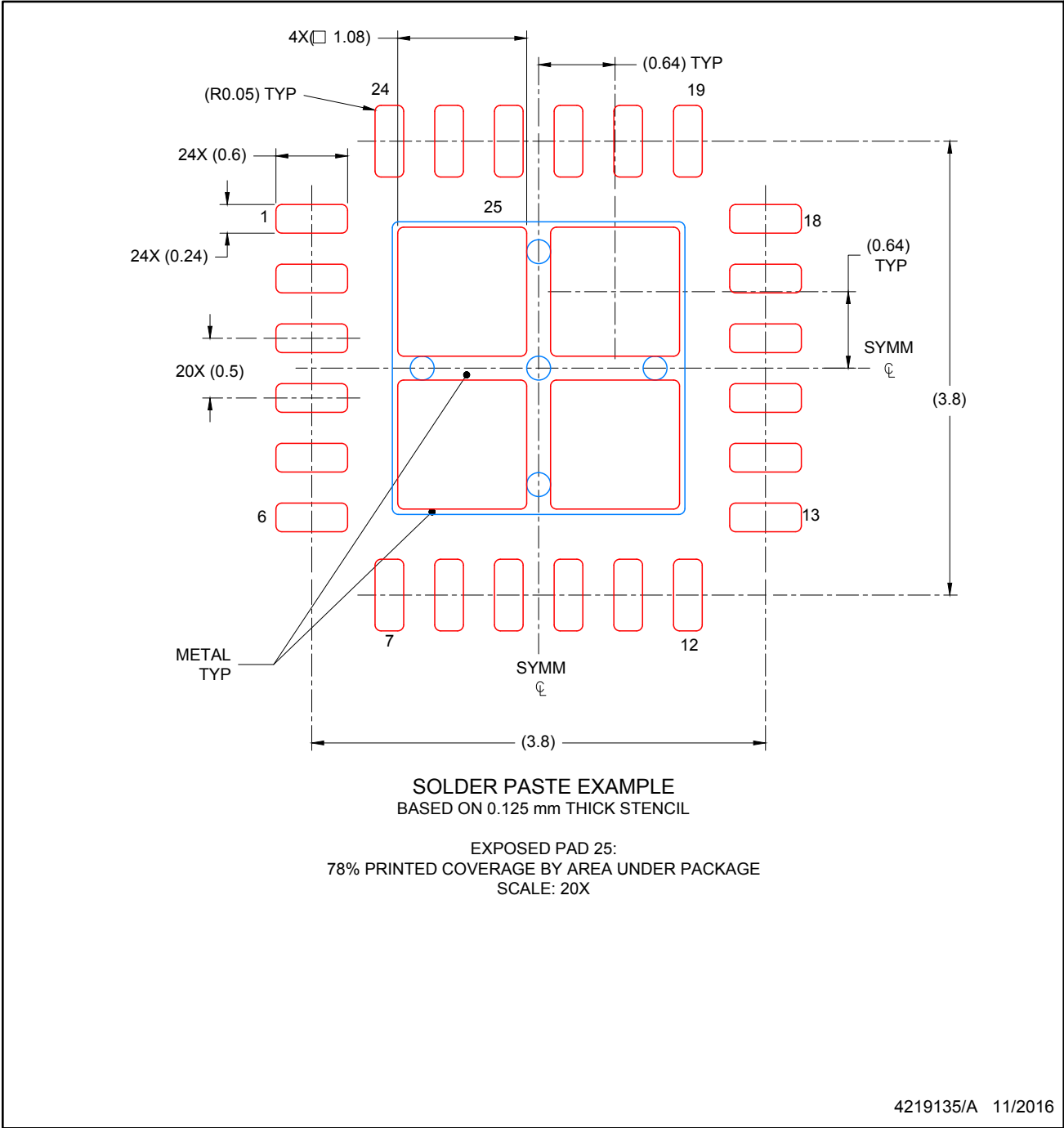
- For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slue271](http://www.ti.com/lit/slue271)).

# EXAMPLE STENCIL DESIGN

WQFN - 0.8 mm max height

RTW0024B

PLASTIC QUAD FLATPACK-NO LEAD



NOTES: (continued)

- 4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.